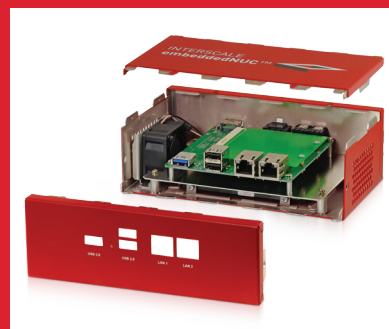


# Interscale for Embedded NUC™

## REQUIREMENT

Customer requested a housing with fan cooling of the Embedded NUC™ standard for use as an Internet of Things (IoT) application.



## CHALLENGE

Small case needed with fan cooling direction from left to right.



## SOLUTION

A 40 mm fan kit is installed on the left side of the enclosure and perforations are positioned on both sides. A hard disk drive is installed under the board with the possibility to open the enclosure on the bottom to access the hard disk drive.

Also compatible with Flexible Heat Conductor for conduction cooling.



### Project details

Location	Germany
Type of system	Interscale for Embedded NUC™
Technology	Protection for board with fan cooling, based on the Embedded NUC™ standard
Product scope	Prototype
Date/Time frame	Q4/2016
Contract scope	5

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